

TLP561J

Triac Driver
Programmable Controllers
AC-Output Module
Solid State Relay

The TOSHIBA TLP561J consists of a zero voltage crossing turn-on photo-triac optically coupled to an infrared emitting diode in a six lead plastic DIP package.

- Peak off-state voltage: 600 V (min)
- Trigger LED current: 10 mA (max)
- On-state current: 100 mA (max)
- Isolation voltage: 2500 V_{rms} (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A
File No.E67349
- VDE-approved: EN 60747-5-5 (Note 1)

Note 1 : When a VDE approved type is needed,
please designate the **Option(D4)**.

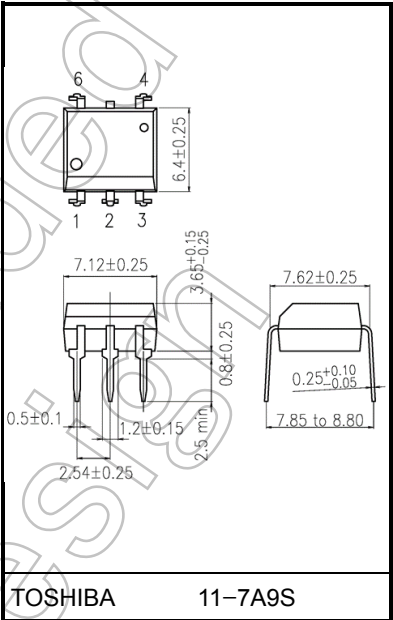
- Trigger LED current

Classification (Note2)	Trigger LED Current (mA)		Marking of Classification
	V _T =6V, T _a =25°C		
	Min	Max	
(IFT7)	—	7	T7
Standard	—	10	T7, blank

Note: Application type name for certification test, please
use standard product type name, i.e.
TLP561J(IFT7): TLP561J

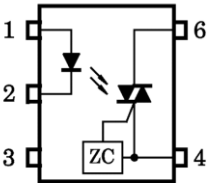
(Note 2): Specify both the part number and a rank in this format when
ordering. Example: TLP561J (IFT7)

Unit: mm



Weight: 0.39g

Pin Configuration (top view)



- 1 : ANODE
- 2 : CATHODE
- 3 : N.C.
- 4 : TERMINAL
- 6 : TERMINAL

Start of commercial production
1986-11

Absolute Maximum Ratings (Ta = 25°C)

Characteristic			Symbol	Rating	Unit
LED	Forward current		I _F	50	mA
	Forward current derating (Ta ≥ 53°C)		ΔI _F /°C	−0.7	mA/°C
	Peak forward current (100 μs pulse, 100 pps)		I _{FP}	1	A
	Reverse voltage		V _R	5	V
	Input power dissipation		P _D	100	mW
	Input power dissipation derating (Ta ≥ 53°C)		ΔP _D /°C	-1.39	mW/°C
	Junction temperature		T _j	125	°C
Detector	Off-state output terminal voltage		V _{DRM}	600	V
	On-state RMS current	Ta = 25°C	I _{T(RMS)}	100	mA
		Ta = 70°C		50	
	On-state current derating (Ta ≥ 25°C)		ΔI _T /°C	−1.1	mA/°C
	Peak on-state current (100 μs pulse, 120 pps)		I _{TP}	2	A
	Peak non-repetitive surge current (Pw = 10ms)		I _{TSM}	1.2	A
	Output power dissipation		P _O	300	mW
	Output power dissipation derating (Ta ≥ 25°C)		ΔP _O /°C	−3.0	mW/°C
	Junction temperature		T _j	115	°C
Storage temperature range			T _{stg}	−55 to 125	°C
Operating temperature range			T _{opr}	−40 to 100	°C
Lead soldering temperature (10 s)			T _{sol}	260	°C
Isolation voltage (AC, 60 s, R.H. ≤ 60 %)(Note 3)			BV _S	2500	V _{rms}

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 3) Device considered a two terminal device: Pins 1, 2 and 3 shorted together pin 4 and 6 shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min	Typ.	Max	Unit
Supply voltage	V _{AC}	—	—	240	V _{ac}
Forward current	I _F	15	20	25	mA
Peak on-state current	I _{TP}	—	—	1	A
Operating temperature	T _{opr}	-25	—	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the devices. Each item also has its own independent guideline document. In developing designs using these products, please confirm the specified characteristics shown in these documents.

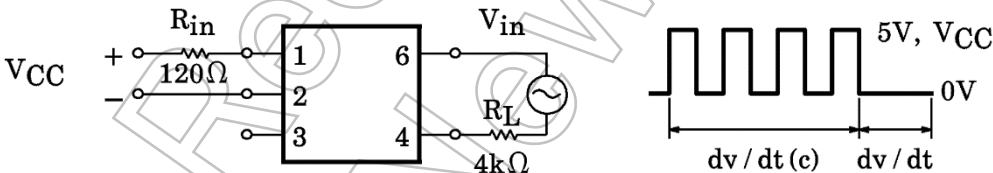
Individual Electrical Characteristics (Ta = 25°C)

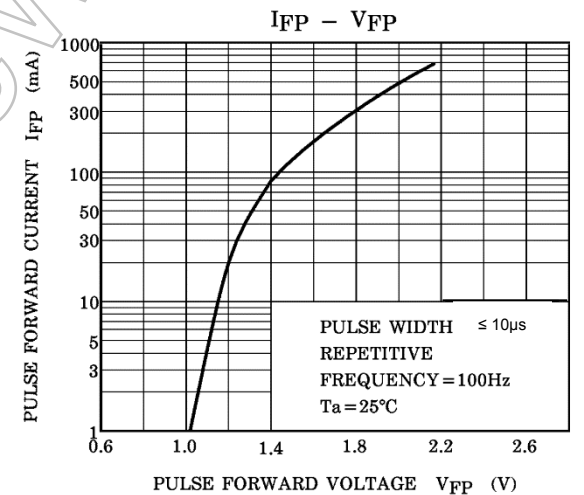
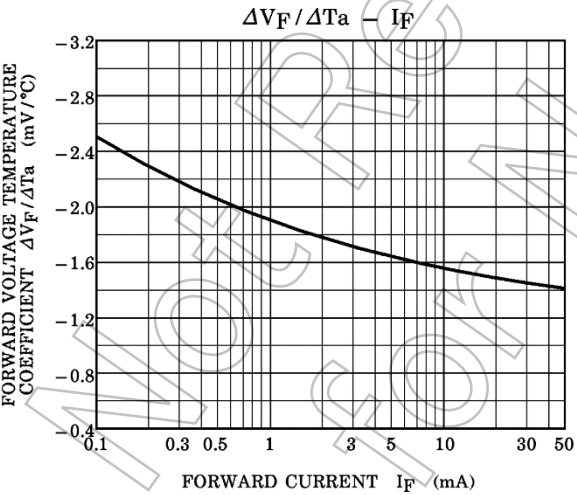
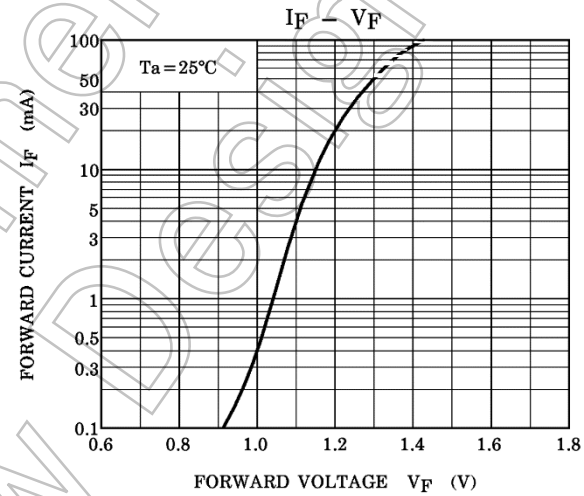
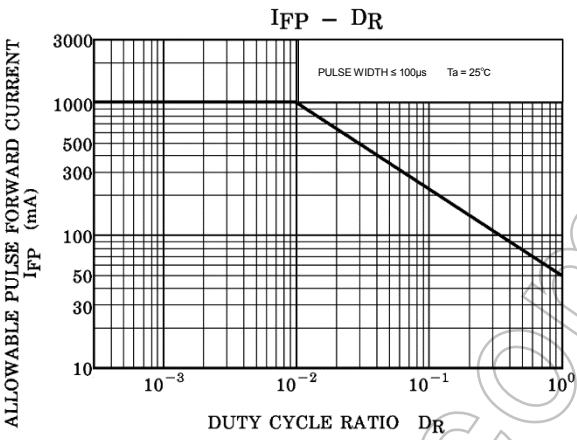
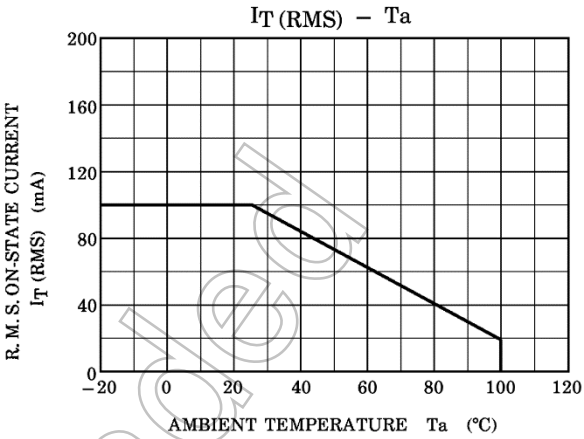
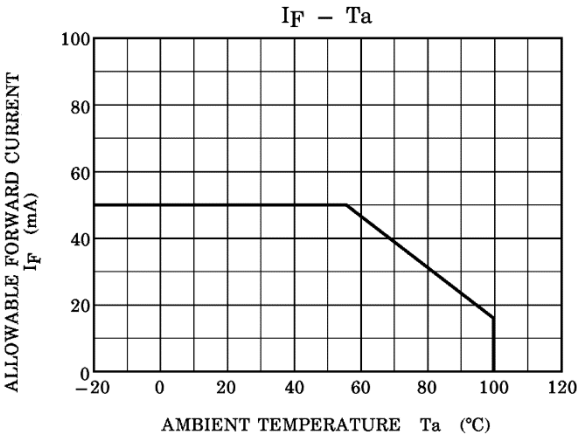
Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V_F	$I_F = 10\text{ mA}$	1.0	1.15	1.3	V
	Reverse current	I_R	$V_R = 5\text{ V}$	—	—	10	μA
	Capacitance	C_T	$V = 0\text{ V}, f = 1\text{ MHz}$	—	30	—	pF
Detector	Peak off-state current	I_{DRM}	$V_{DRM} = 600\text{ V}$	—	10	1000	nA
	Peak on-state voltage	V_{TM}	$I_{TM} = 100\text{ mA}$	—	1.7	3.0	V
	Holding current	I_H	—	—	0.6	—	mA
	Critical rate of rise of off-state voltage	dv/dt	$V_{in} = 240\text{ V}_{rms}, Ta = 85\text{ }^\circ\text{C}$ (Fig.1)	200	500	—	V / μs
	Critical rate of rise of commutating voltage	$dv/dt(c)$	$V_{in} = 60\text{ V}_{rms}, I_T = 15\text{ mA}$ (Fig.1)	—	0.2	—	V / μs

Coupled Electrical Characteristics (Ta = 25°C)

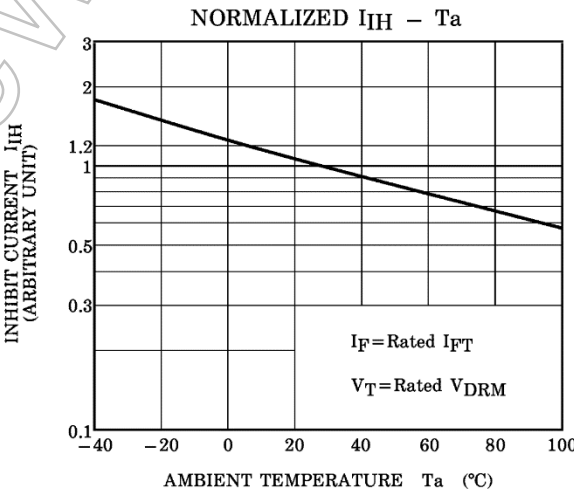
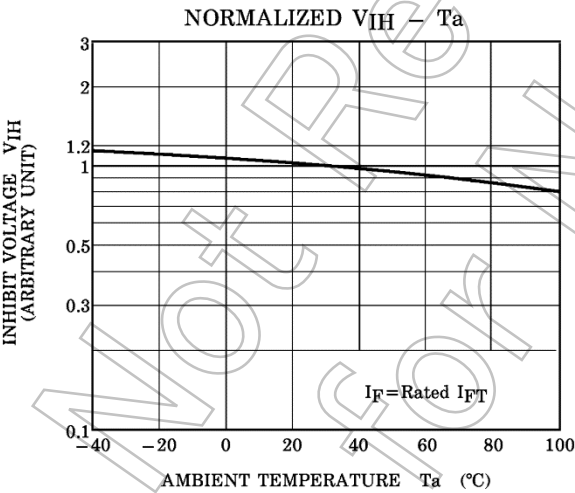
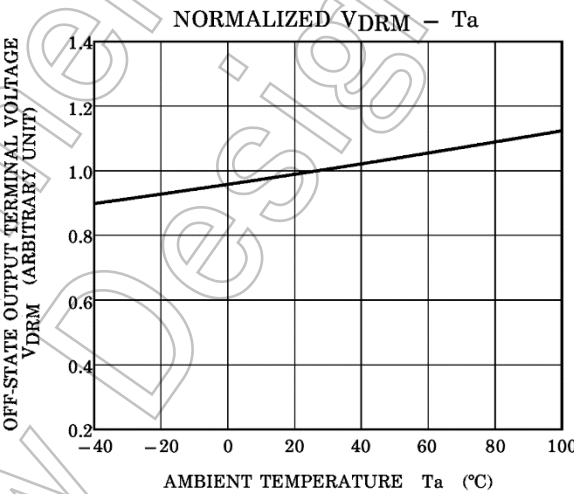
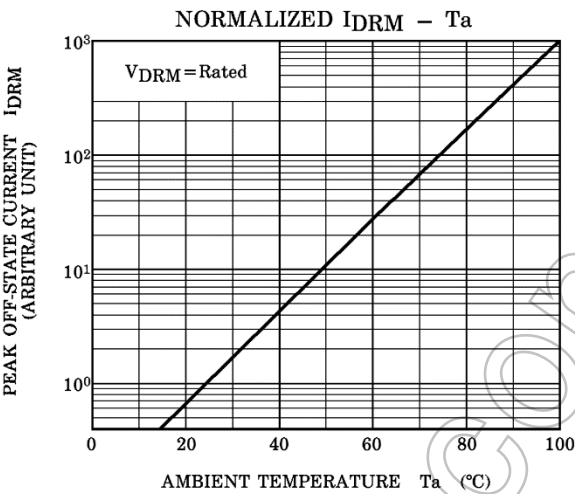
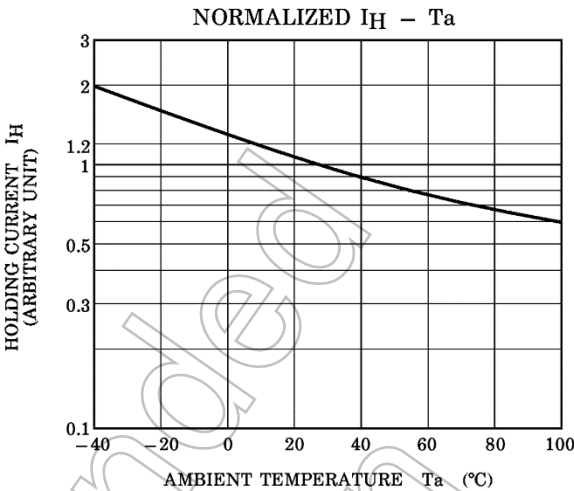
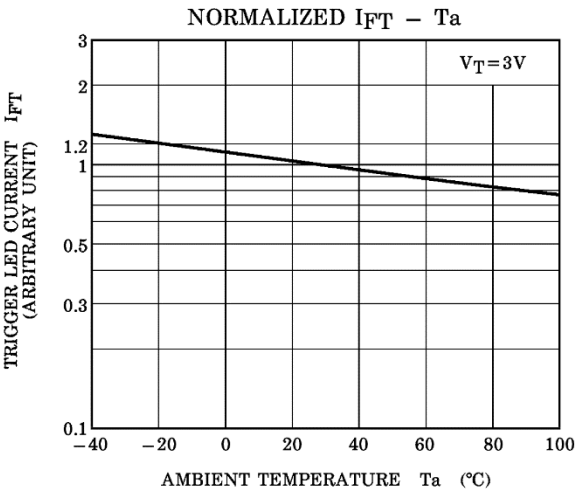
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Trigger LED current	I_{FT}	$V_T = 6\text{ V}, R_L = 100\text{ }\Omega$	—	5	10	mA
Inhibit voltage	V_{IH}	$I_F = \text{Rated } I_{FT}$	—	—	50	V
Leakage in inhibited state	I_{IH}	$I_F = \text{Rated } I_{FT}$ $V_T = \text{Rated } V_{DRM}$	—	200	600	μA
Capacitance (input to output)	C_S	$V_S = 0\text{ V}, f = 1\text{ MHz}$	—	0.8	—	pF
Isolation resistance	R_S	$V_S = 500\text{ V}, \text{R.H.} \leq 60\text{ }\%$	5×10^{10}	10^{14}	—	Ω
Isolation voltage	BV_S	AC, 60 s	2500	—	—	V_{rms}

Fig.1: dv / dt test circuit





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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